Transistors Panasonic

2SA2010

Silicon PNP epitaxial planar type

For DC-DC converter

For various driver circuits

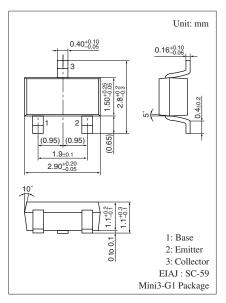
■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- High-speed switching
- Mini type package, allowing downsizing and thinning of the equipment and automatic insertion through the tape packing.

■ Absolute Maximum Ratings $T_a = 25$ °C

| Parameter | Symbol | Rating | Unit | |
|---------------------------------------|------------------|-------------|------|--|
| Collector-base voltage (Emitter open) | V _{CBO} | -15 | V | |
| Collector-emitter voltage (Base open) | V _{CEO} | -15 | V | |
| Emitter-base voltage (Collector open) | V_{EBO} | -5 | V | |
| Collector current | I_C | -2.5 | A | |
| Peak collector current | I_{CP} | -10 | A | |
| Collector power dissipation * | P _C | 600 | mW | |
| Junction temperature | T_{j} | 150 | °C | |
| Storage temperature | T _{stg} | -55 to +150 | °C | |

Note) *: Measure on the ceramic substrate at 15 mm \times 15 mm \times 0.6 mm



Marking Symbol: AS

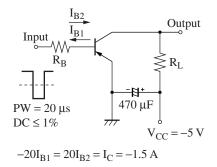
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|--|----------------------|--|-----|------|-------|------|
| Collector-base voltage (Emitter open) | V _{CBO} | $I_C = -10 \ \mu A, I_E = 0$ | -15 | | | V |
| Collector-emitter voltage (Base open) | V _{CEO} | $I_C = -1 \text{ mA}, I_B = 0$ | -15 | | | V |
| Emitter-base voltage (Collector open) | V _{EBO} | $I_E = -10 \ \mu A, I_C = 0$ | -5 | | | V |
| Collector-base cutoff current (Emitter open) | I_{CBO} | $V_{CB} = -10 \text{ V}, I_E = 0$ | | | - 0.1 | μΑ |
| Forward current transfer ratio * | h _{FE1} | $V_{CE} = -2 \text{ V}, \ I_{C} = -100 \text{ mA}$ | 200 | | 560 | _ |
| | h _{FE2} | $V_{CE} = -2 \text{ V}, \ I_{C} = -2.5 \text{ A}$ | 100 | | | |
| Collector-emitter saturation voltage * | V _{CE(sat)} | $I_C = -1 \text{ A}, I_B = -10 \text{ mA}$ | | -140 | | mV |
| | | $I_C = -2.5 \text{ A}, I_B = -50 \text{ mA}$ | | -270 | -320 | |
| Transition frequency | f_T | $V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$ | | 180 | | MHz |
| Collector output capacitance | C _{ob} | $V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$ | | 40 | | pF |
| (Common base, input open circuited) | | | | | | |
| Turn-on time | t _{on} | Refer to the measurement circuit | | 35 | | ns |
| Turn-off time | t _{off} | | | 10 | | ns |
| Storage time | t _{stg} | | | 110 | | ns |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

^{2. *:} Pulse measurement

■ Measurement Circuit



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